



Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectionals	Material Info	Subsectionals	D, A																									
Supplier Information																																		
Company Name	TE Connectivity	Request Document ID		Contact Name	JASON KUNTZ	Contact Title	Product Compliance Engineer																											
Company Unique ID	TE Connectivity	Response Date	2015-04-13	Contact Email	jp.kuntz@te.com																													
Contact Phone Number		717-986-5932																																
Legal Statement																																		
Supplier Acceptance	true																																	
Legal Statement																																		
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.																																		
Product																																		
Manufacturer Item number	104652-5	Amount	684.4254818	Version	-	Identity																												
Manufacturer Item Name	50 50/50 GRID DRST SFMNT RCPT	Weight Uom	mg	Mfr Site		Authority																												
Date		UOM	Each																															
EUROHS-0508	Product(s) does not meet EU RoHS requirements and is not under exemptions																																	
ChinaRoHS-0508	Product(s) is NOT eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products																																	
EUREACH-1213	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH																																	
Product Disclosure																																		
Sub-Item/Material/Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption																									
Sub-Item	1	50/50 GRID STND HLDWN PLTD				2.0	29.2127409	mg																										
Material	2	Nickel Plate				2.0	0.2340809	mg																										
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	2.0	4.6816E-4	mg																										
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	2.0	2.3408E-4	mg																										
Substance	3	Nickel	Nickel	7440-02-0	99.7	2.0	0.23338	mg																										
Material	2	Tin-Lead Plate				2.0	0.34166	mg																										
Substance	3	Tin	Supplier	7440-31-5	92.3	2.0	0.31535	mg																										
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.7	2.0	0.00239162	mg																										
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	7.0	2.0	0.0239162	mg																										
Material	2	Beryllium Copper				2.0	28.637	mg																										
Substance	3	Beryllium	Supplier	7440-41-7	2.0	2.0	0.57274	mg																										
Substance	3	Arsenic	Supplier	7440-38-2	0.01	2.0	0.0028637	mg																										
Substance	3	Manganese	Supplier	7439-96-5	0.02	2.0	0.0057274	mg																										
Substance	3	Cobalt	Supplier	7440-48-4	0.2	2.0	0.057274	mg																										
Substance	3	Silicon	Supplier	7440-21-3	0.2	2.0	0.057274	mg																										
Substance	3	Iron	Supplier	7439-89-6	0.4	2.0	0.11455	mg																										
Substance	3	Antimony	Supplier	7440-36-0	0.01	2.0	0.0028637	mg																										
Substance	3	Aluminum	Supplier	7429-90-5	0.2	2.0	0.057274	mg																										
Substance	3	Chromium	Supplier	7440-47-3	0.0010	2.0	2.8637E-4	mg																										
Substance	3	Copper	Supplier	7440-50-8	96.649	2.0	27.67737	mg																										
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	2.0	0.028637	mg																										
Substance	3	Nickel	Nickel	7440-02-0	0.2	2.0	0.057274	mg																										
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0050	2.0	0.00143185	mg																										
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	2.0	1.4318E-4	mg																										
Sub-Item	1	50 50/50 GRID DRST RCPT HSG				1.0	401.0	mg																										
Material	2	LIQUID CRYSTAL PLOYMER				1.0	401.0	mg																										

Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0909	3.0	1.0	12.03	mg	
Substance	3	Liquid Crystal Polymer - ISO 1043-1 Term LCP	Supplier	1043-1-LCP	67.0	1.0	268.67	mg	
Substance	3	Glass, oxide, chemicals	Supplier	65997-17-3	30.0	1.0	120.3	mg	
Sub-Item	1	50/50 GRID RCPT CONT PLTD				50.0	4.5	mg	
Material	2	Copper Alloy				50.0	4.13921	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	50.0	0.0020696	mg	
Substance	3	Zinc	Supplier	7440-66-6	1.0	50.0	0.0413921	mg	
Substance	3	Silicon	Supplier	7440-21-3	1.2	50.0	0.04967052	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	50.0	0.00413921	mg	
Substance	3	Copper	Supplier	7440-50-8	92.7635	50.0	3.83968	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.06	50.0	0.00248353	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	50.0	4.13921E-5	mg	
Substance	3	Magnesium	Supplier	7439-95-4	0.3	50.0	0.01241763	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.1	50.0	0.00413921	mg	
Substance	3	Iron	Supplier	7439-89-6	0.2	50.0	0.00827842	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.01	50.0	4.1392E-4	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	50.0	4.1392E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	4.2	50.0	0.17385	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0050	50.0	2.0696E-4	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	50.0	2.069605E-5	mg	
Material	2	Nickel Plate				50.0	0.236	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	50.0	4.72E-4	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	50.0	2.36E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	50.0	0.23529	mg	
Material	2	Tin-Lead Plate				50.0	0.073	mg	
Substance	3	Tin	Supplier	7440-31-5	92.3	50.0	0.067379	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.7	50.0	5.11E-4	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	7.0	50.0	0.00511	mg	
Material	2	Gold Plate				50.0	0.05179	mg	
Substance	3	Gold	Supplier	7440-57-5	99.7	50.0	0.05163463	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0909	0.3	50.0	1.5537E-4	mg	